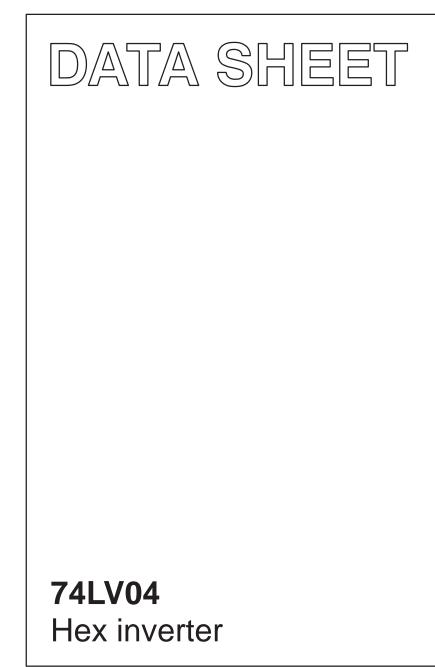
INTEGRATED CIRCUITS



Product specification Supersedes data of 1997 Feb 03 IC24 Data Handbook 1998 Apr 20



Philips Semiconductors

74LV04

FEATURES

- Wide operating voltage: 1.0 to 5.5 V
- Optimized for low voltage applications: 1.0 to 3.6 V
- Accepts TTL input levels between V_{CC} = 2.7 V and V_{CC} = 3.6 V
- Typical V_{OLP} (output ground bounce) < 0.8 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}C$
- Typical V_{OHV} (output V_{OH} undershoot) > 2 V at V_{CC} = 3.3 V, $T_{amb} = 25^{\circ}C$
- Output capability: standard
- I_{CC} category: SSI

QUICK REFERENCE DATA

GND = 0 V; $T_{amb} = 25^{\circ}C$; $t_r = t_f \le 2.5$ ns

DESCRIPTION

The 74LV04 is a low-voltage Si-gate CMOS device that is pin and function compatible with 74HC/HCT04.

The 74LV04 provides six inverting buffers.

SYMBOL	PARAMETER	PARAMETER CONDITIONS			
t _{PHL} /t _{PLH}		$\begin{array}{l} C_L = 15 \text{ pF}; \\ V_{CC} = 3.3 \text{ V} \end{array}$	6	ns	
Cl	Input capacitance		3.5	pF	
C _{PD}	Power dissipation capacitance per gate	See Notes NO TAG and 2	21	pF	

NOTES:

- C_{PD} is used to determine the dynamic power dissipation (P_D in μ W) 1. P_D = C_{PD} × V_{CC}² × f_i + \sum (C_L × V_{CC}² × f_o) where: f_i = input frequency in MHz; C_L = output load capacitance in pF; f_o = output frequency in MHz; V_{CC} = supply voltage in V; \sum (C_L × V_{CC}² × f_o) = sum of the outputs. 2. The condition is V₁ is V₁ = GND to V_{CC}.

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	PKG. DWG. #
14-Pin Plastic DIL	–40°C to +125°C	74LV04 N	74LV04 N	SOT27-1
14-Pin Plastic SO	–40°C to +125°C	74LV04 D	74LV04 D	SOT108-1
14-Pin Plastic SSOP Type II	–40°C to +125°C	74LV04 DB	74LV04 DB	SOT337-1
14-Pin Plastic TSSOP Type I	–40°C to +125°C	74LV04 PW	74LV04PW DH	SOT402-1

PIN DESCRIPTION

PIN NUMBER	SYMBOL	FUNCTION		
1, 3, 5, 9, 11, 13	1A – 6A	Data inputs		
2, 4, 6, 8, 10, 12	1Y – 6Y	Data outputs		
7	GND	Ground (0 V)		
14	V _{CC}	Positive supply voltage		

FUNCTION TABLE

INPUTS	OUTPUTS			
nA	nY			
L	Н			
н	L			

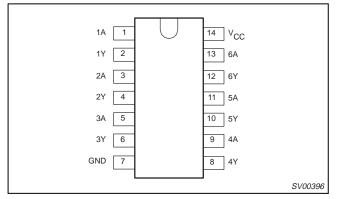
NOTES:

H = HIGH voltage level

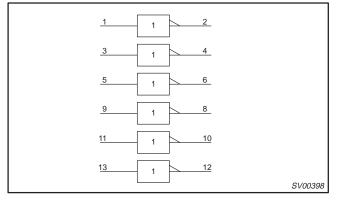
L = LOW voltage level

74LV04

PIN CONFIGURATION



LOGIC SYMBOL (IEEE/IEC)



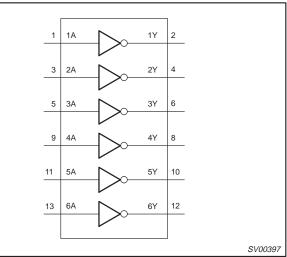
RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	MIN	TYP	MAX	UNIT
V _{CC}	DC supply voltage	See Note ^{NO TAG}	1.0	3.3	5.5	V
VI	Input voltage		0	-	V _{CC}	V
Vo	Output voltage		0	-	V _{CC}	V
T _{amb}	Operating ambient temperature range in free air	See DC and AC characteristics	-40 -40		+85 +125	°C
t _r , t _f	Input rise and fall times	$\begin{array}{l} V_{CC} = 1.0V \mbox{ to } 2.0V \\ V_{CC} = 2.0V \mbox{ to } 2.7V \\ V_{CC} = 2.7V \mbox{ to } 3.6V \\ V_{CC} = 3.6V \mbox{ to } 5.5V \end{array}$			500 200 100 50	ns/V

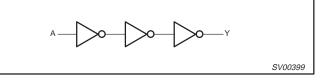
NOTE:

1. The LV is guaranteed to function down to V_{CC} = 1.0V (input levels GND or V_{CC}); DC characteristics are guaranteed from V_{CC} = 1.2V to V_{CC} = 5.5V.

LOGIC SYMBOL



LOGIC DIAGRAM (ONE INVERTER)



74LV04

ABSOLUTE MAXIMUM RATINGSNO TAG, NO TAG

In accordance with the Absolute Maximum Rating System (IEC 134). Voltages are referenced to GND (ground = 0V).

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +7.0	V
$\pm I_{IK}$	DC input diode current	$V_{I} < -0.5 \text{ or } V_{I} > V_{CC} + 0.5 V$	20	mA
± I _{OK}	DC output diode current	$V_{\rm O}$ < -0.5 or $V_{\rm O}$ > $V_{\rm CC}$ + 0.5V	50	mA
$\pm I_{O}$	DC output source or sink current – standard outputs	$-0.5V < V_O < V_{CC} + 0.5V$	25	mA
$^{\pmI_{GND},}_{\pmI_{CC}}$	DC V _{CC} or GND current for types with – standard outputs		50	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package – plastic DIL – plastic mini-pack (SO) – plastic shrink mini-pack (SSOP and TSSOP)	for temperature range: -40 to +125°C above +70°C derate linearly with 12 mW/K above +70°C derate linearly with 8 mW/K above +60°C derate linearly with 5.5 mW/K	750 500 400	

NOTES:

 Stresses beyond those listed may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

2. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

					LIMITS			
SYMBOL	PARAMETER	TEST CONDITIONS	-40	°C to +8	5°C	-40°C to	o +125°C	
			MIN	TYP. NO TAG	МАХ	MIN	MAX	
		$V_{CC} = 1.2V$	0.9			0.9		
	HIGH level Input	$V_{CC} = 2.0 V$	1.4			1.4		V
VН	V _{IH} voltage	V _{CC} = 2.7 to 3.6V	2.0			2.0		1 [×]
		$V_{CC} = 4.5 \text{ to } 5.5 \text{V}$	0.7 * V _{CC}			0.7 * V _{CC}		
		$V_{CC} = 1.2V$			0.3		0.3	
V.	VIL LOW level Input	$V_{CC} = 2.0V$			0.6		0.6	V
VIL voltage	V _{CC} = 2.7 to 3.6V			0.8		0.8	Ì	
		V _{CC} = 4.5 to 5.5			0.3 * V _{CC}		0.3 * V _{CC}	
	V _{OH} HIGH level output voltage; all outputs	V_{CC} = 1.2V; V_I = V_{IH} or $V_{IL;}$ – I_O = 100 μ A		1.2				
		V_{CC} = 2.0V; V_I = V_{IH} or V_{IL} ; $-I_O$ = 100 μ A	1.8	2.0		1.8		
V _{OH}		$V_{CC} = 2.7V; V_I = V_{IH} \text{ or } V_{IL;} - I_O = 100 \mu A$	2.5	2.7		2.5		V
		V_{CC} = 3.0V; V_I = V_{IH} or V_{IL} ; $-I_O$ = 100 μ A	2.8	3.0		2.8		
		V_{CC} = 4.5V; V_I = V_{IH} or $V_{IL;}$ – I_O = 100 μ A	4.3	4.5		4.3		
V _{ОН}	HIGH level output voltage;	V_{CC} = 3.0V; V_{I} = V_{IH} or V_{IL} ; $-I_{O}$ = 6mA	2.40	2.82		2.20		v
VОн	STANDARD outputs	V_{CC} = 4.5V; V_{I} = V_{IH} or $V_{IL;}$ – I_{O} = 12mA	3.60	4.20		3.50		ľ
		V_{CC} = 1.2V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		0				
		V_{CC} = 2.0V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		0	0.2		0.2	
V _{OL}	LOW level output voltage; all outputs	V_{CC} = 2.7V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		0	0.2		0.2	V
		V_{CC} = 3.0V; V_I = V_{IH} or V_{IL} ; I_O = 100 μ A		0	0.2		0.2	
		V_{CC} = 4.5V; V_I = V_{IH} or $V_{IL;} I_O$ = 100 μ A		0	0.2		0.2	
V _{OL}	LOW level output voltage;	V_{CC} = 3.0V; V_{I} = V_{IH} or V_{IL} ; I_{O} = 6mA		0.25	0.40		0.50	v
۶OL	STANDARD outputs	V_{CC} = 4.5V; V_I = V_{IH} or $V_{IL;}$ I_O = 12mA		0.35	0.55		0.65	

74LV04

DC ELECTRICAL CHARACTERISTICS (Continued)

Over recommended operating conditions. Voltages are referenced to GND (ground = 0V).

			LIMITS						
SYMBOL	PARAMETER	TEST CONDITIONS	-40	°C to +85	5°C	-40°C to			
			MIN	TYP. NO TAG	MAX	MIN	МАХ		
I	Input leakage current	V_{CC} = 5.5V; V_{I} = V_{CC} or GND			1.0		1.0	μΑ	
I _{CC}	Quiescent supply current; SSI	V_{CC} = 5.5V; V_{I} = V_{CC} or GND; I_{O} = 0			20.0		40	μΑ	
ΔI _{CC}	Additional quiescent supply current	$V_{CC} = 2.7V$ to 3.6V; $V_{I} = V_{CC} - 0.6V$			500		850	μΑ	

NOTE:

1. All typical values are measured at $T_{amb} = 25^{\circ}C$.

AC CHARACTERISTICS

GND = 0V; $t_r = t_f \le 2.5$ ns; $C_L = 50$ pF; $R_L = 1$ K Ω

		CONDITION									
SYMBOL	PARAMETER	WAVEFORM	CONDITION	-	40 to +85°	С	–40 to +125°C		UNIT		
			V _{CC} (V)	MIN	TYP NO TAG	МАХ	MIN	MAX			
					1.2		40				
			2.0		14	20		25			
t _{PHL} /t _{PLH}	Propagation delay nA to nY	Figure 1	2.7		10	15		19	ns		
			3.0 to 3.6		8 ^{NO TAG}	12		15			
			4.5 to 5.5			9		11			

NOTES:

1. Unless otherwise stated, all typical values are measured at $T_{amb} = 25^{\circ}C$ 2. Typical values are measured at $V_{CC} = 3.3 \text{ V}$.

AC WAVEFORMS

 V_M = 1.5 V at $V_{CC} \ge 2.7$ V and ≤ 3.6 V; V_M = 0.5 \times V_{CC} at V_{CC} < 2.7 V and \geq 4.5 V; $V_{\mbox{OL}}$ and $V_{\mbox{OH}}$ are the typical output voltage drop that occur with the output load.

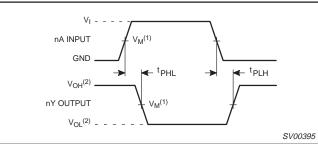


Figure 1. Input (nA) to output (nY) propagation delays and output transition times.

TEST CIRCUIT

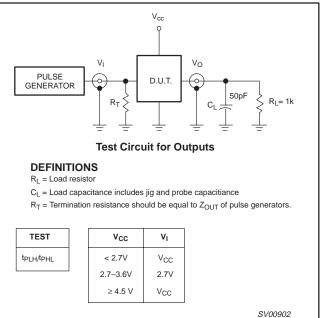
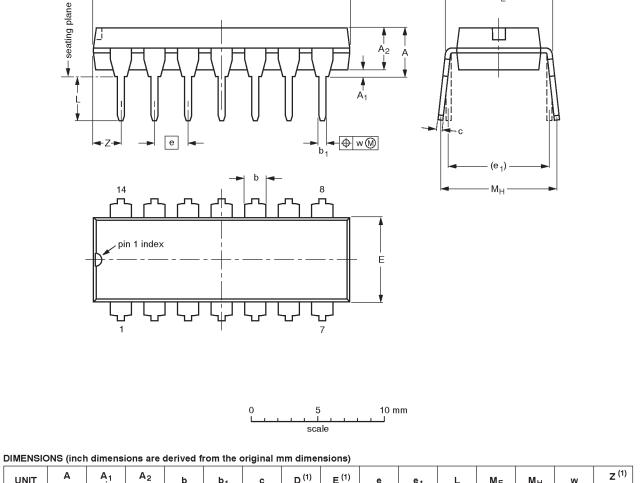


Figure 2. Load circuitry for switching times

DIP14: plastic dual in-line package; 14 leads (300 mil)

Г



UNIT	A max.	A ₁ min.	A ₂ max.	b	b ₁	c	D ⁽¹⁾	E ⁽¹⁾	e	e ₁	L	ME	M _H	w	Z ⁽¹⁾ max.
mm	4.2	0.51	3.2	1.73 1.13	0.53 0.38	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	2.2
inches	0.17	0.020	0.13	0.068 0.044	0.021 0.015	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.087

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE		REFER	EUROPEAN	ISSUE DATE		
VERSION	IEC	JEDEC	EIAJ		PROJECTION	ISSUE DATE
SOT27-1	050G04	MO-001AA				-92-11-17 95-03-11

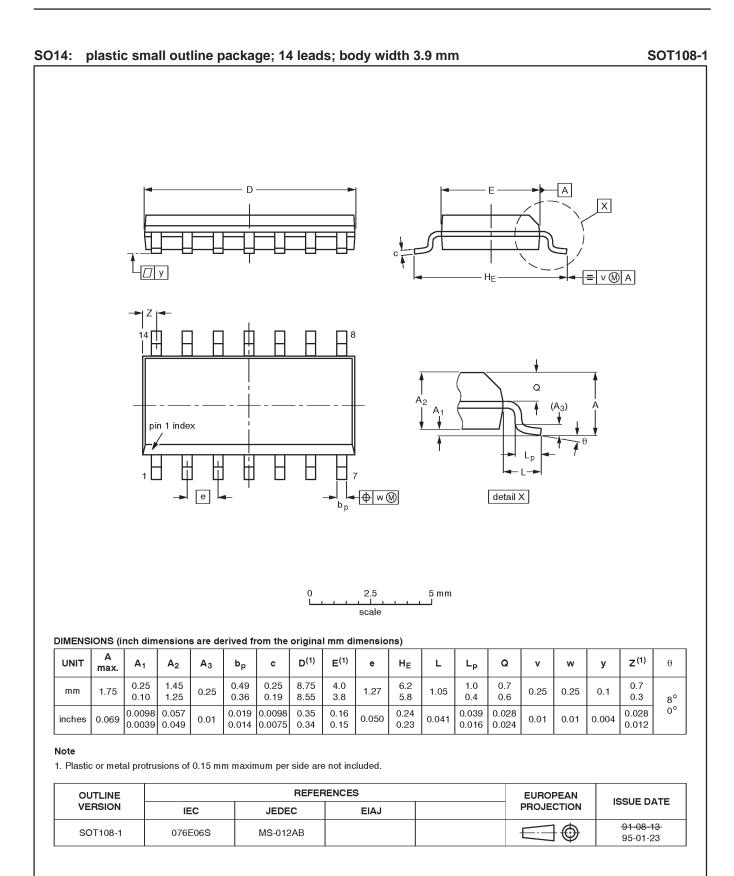
Product specification

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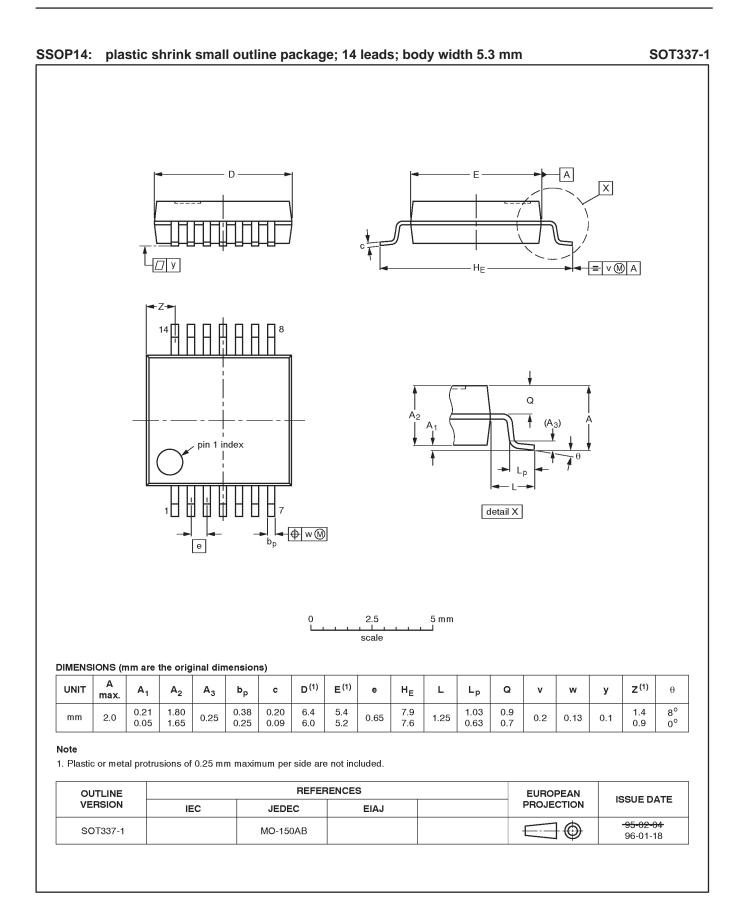
SOT27-1

 M_E

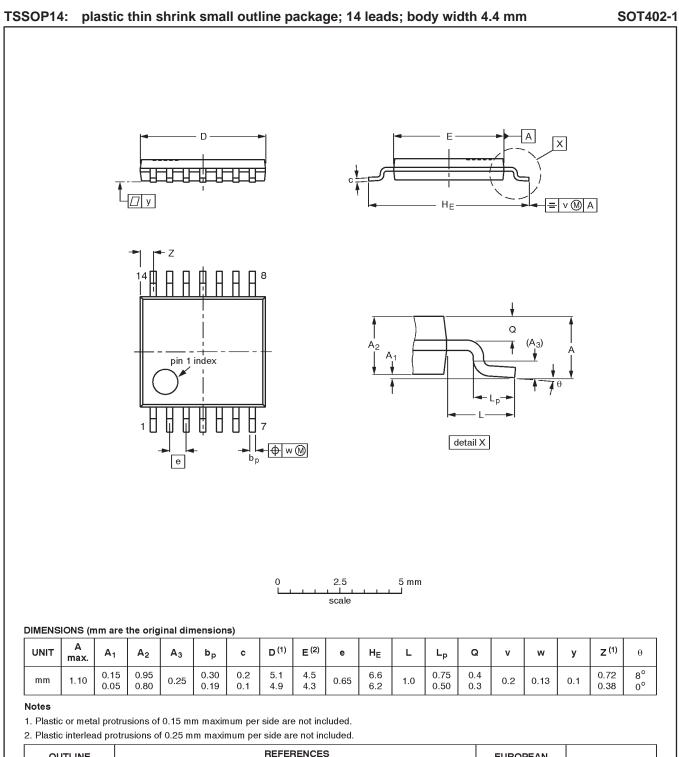
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1998 Apr 20

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DEFINITIONS						
Data Sheet Identification	Product Status	Definition				
Objective Specification	Formative or in Design	This data sheet contains the design target or goal specifications for product development. Specifications may change in any manner without notice.				
Preliminary Specification	Preproduction Product	This data sheet contains preliminary data, and supplementary data will be published at a later date. Philips Semiconductors reserves the right to make changes at any time without notice in order to improve design and supply the best possible product.				
Product Specification	Full Production	This data sheet contains Final Specifications. Philips Semiconductors reserves the right to make changes at any time without notice, in order to improve design and supply the best possible product.				

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